	BLE STAN				torage				
	Operating Temperature Range				Forage Femperature Range		-10 °C to 6	-10 °C to 60 °C (2)	
Rating	Voltage Current		Power Contact : 200 V AC Signal Contact : 0.5 A		torage Hur	age Humidity Range Relative humidity 85		% max	c
					perating Humidity Range (Not dewed				
			SPEC	IFICATION	NS				
ITI	EM		TEST METHOD			REQU	IREMENTS	QT	A
CONSTRU	JCTION								
General Examination		Visually and by measuring instrument.			Accord	According to drawing.			>
Marking		Confirmed visually.]			;
ELECTRIC CHARAC									
Contact Resistance		100 mA(DC or 1000Hz)			-	Signal Contact : $70m \Omega$ MAX. Power Contact : $20m \Omega$ MAX.			-
Insulation Resistance		Signal Contact : 100 V DC. Power Contact : 250 V DC			-	Signal Contact : 100 M Ω MIN. Power Contact : 1000 M Ω MIN.			-
Voltage Proof		Signal Contact : 150 V AC for 1 min.				No flashover or breakdown.			;
		Power Contact : 600 V AC for 1 min.			no fias				-
MECHANI	CAL CHAR								
Insertion and		Measured by applicable connector.				Insertion Force: 36 N MAX.			-
Withdrawal Forces						Withdrawal Force: 4 N MIN.			_
Mechanical Operation		100 times insertions and extractions.			S	 Contact Resistance: Signal Contact : 80m Ω MAX. Power Contact : 30m Ω MAX. No damage, crack and looseness of parts. 			
Vibration		Frequency 10 to 55 to 10Hz, approx 5min Single amplitude : 0.75 mm, 10 cycles			 No 	 No electrical discontinuity of 1 μs. No damage, crack and looseness of parts. 			-
Shock		for 3 axial directions. 490 m/s ² , duration of pulse 11 ms			_			×	-
			for 3 both axial directions.						
	MENTAL C							×	—
Damp Heat (Steady state)		Exposed at 40±2 °C, 90 ~ 95 %, 96 h.			s	① Contact Resistance: Signal Contact : 80m Ω MAX.			-
Rapid Change of Temperature		Temperature-55 \rightarrow +85 °CTime30 \rightarrow 30 min.			Power Contact : 30m Ω MAX. ② Insulation Resistance:			×	-
remperature		under 5			~	Signal Contact			
		(Relocation time to chamber : within 2~3 MIN)			F	Power Contact			
Cold		Exposed at -55°C, 96 h						×	-
Dry Heat		Exposed at 105°C, 96 h						×	-
Sulfur Dioxide Resistance to		Exposed at 25±2°C, 75±5%RH, 25 PPM for 96 h. (Test standard: IEC 68) 1)Reflow soldering :			 No defect such as corrosion which impairs 			×	1-
					② Cor S	the function of connector. (2) Contact Resistance: Signal Contact : 80m Ω MAX. Power Contact : 30m Ω MAX. No deformation of case of excessive			
									1-
Soldering Heat		Peak TMP : 260°CMAX Reflow TMP: 220°CMIN for 60sec			loosen	looseness of the terminal.			
			g irons : 360°C MAX. for 5	sec.				×	
Solderability		Soldered at solder temperature $240\pm3^{\circ}$ C for immersion duration, 3 sec.			minimu	A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.			-
COUN			N OF REVISIONS	חבפו	GNED		CHECKED		ATE
0000				-			HT. YAMAGUCHI		
	DIS-F-00002064		13.	TS. 00N0			17.02.0		
	REMARKS ⁽¹⁾ Include temperature rise caused by current-carrying. ⁽²⁾ "STORAGE" means a long-term storage state for the unused product before assembly to PCB.					APPROVED CHECKED	HS. OKAWA KN. SHIBUYA	14.09.0 14.09.0	
REMARKS		y to PCB.				DESIGNED	TS. 00N0	14.09.	
REMARKS (before assembl								
Unless othe	before assembl erwise speci	fied, refer to	o IEC 60512.			DRAWN	TS. 00N0	14.0)9. C
Unless othe	before assembl erwise speci ualification Tes	fied, refer to st AT:Assu	o IEC 60512. rance Test X:Applicable Te XATION SHEET		DRAWIN	DRAWN		14.0)9. (